

Nine-Output 3.3 V Buffer

Features

- One-input to nine-output buffer/driver
- Supports two DIMMs or four SO-DIMMs with one additional output for feedback to an external or chipset phase-locked loop (PLL)
- Low power consumption for mobile applications

 □ Less than 32 mA at 66.6 MHz with unloaded outputs
- 1-ns input-output delay
- Buffers all frequencies from 2 MHz to 133.33 MHz
- Output-output skew less than 250 ps
- Multiple V_{DD} and V_{SS} pins for noise and electromagnetic interference (EMI) reduction
- Space-saving 16-pin 150-mil small-outline integrated circuit (SOIC) package
- 3.3-V operation
- Industrial temperature available

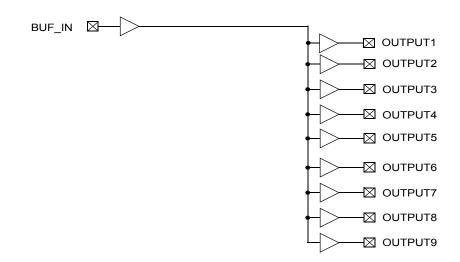
Functional Description

The CY2309NZ is a low-cost buffer designed to distribute high-speed clocks in mobile PC systems and desktop PC systems with SDRAM support. The part has nine outputs, eight of which can be used to drive two DIMMs or four SO-DIMMs, and the remaining can be used for external feedback to a PLL. The device operates at 3.3 V and outputs can run up to 133.33 MHz.

The CY2309NZ is designed for low EMI and power optimization. It has multiple V_{SS} and V_{DD} pins for noise optimization and consumes less than 32 mA at 66.6 MHz, making it ideal for the low-power requirements of mobile systems. It is available in an ultra-compact 150-mil 16-pin SOIC package.

For a complete list of related documentation, click here.

Logic Block Diagram





Contents

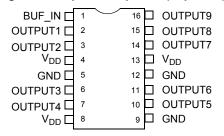
Pinout	3
Pin Descriptions	3
Maximum Ratings	
Operating Conditions	4
Electrical Characteristics	4
Thermal Resistance	4
Switching Characteristics	
Switching Waveforms	
Test Circuits	
Ordering Information	
Ordering Code Definitions	

Package Diagram	ბ
Acronyms	9
Document Conventions	g
Units of Measure	<u>C</u>
Document History Page	10
Sales, Solutions, and Legal Information	
Worldwide Sales and Design Support	11
Products	11
PSoC®Solutions	
Cypress Developer Community	11
Technical Support	



Pinout

Figure 1. 16-pin SOIC pinout (Top View)



Pin Descriptions

Pin	Signal	Description			
4, 8, 13	V_{DD}	3-V digital voltage supply			
5, 9, 12	GND	Ground			
1	BUF_IN	Input clock			
2, 3, 6, 7, 10, 11, 14, 15, 16	OUTPUT [1:9]	Outputs			



Maximum Ratings

Supply voltage to ground potential-0.5 V to +7.0 V DC input voltage-0.5 V to 7.0 V

Storage temperature	–65 °C to +150 °C
Junction temperature	150 °C
Static discharge voltage	
(per MIL-STD-883, Method 3015)	>2,000 V

Operating Conditions

For commercial and industrial temperature devices

Parameter	Description	Min	Max	Unit
V_{DD}	Supply voltage	3.0	3.6	V
T _A	(Ambient operating temperature) commercial	0	70	°C
	(Ambient operating temperature) industrial	-40	85	°C
C _L	Load capacitance, Fout < 100 MHz	_	30	pF
	Load capacitance,100 MHz < Fout < 133.33 MHz	_	15	pF
C _{IN}	Input capacitance	_	7	pF
BUF_IN, OUTPUT [1:9]	Operating frequency	2	133.33	MHz
t _{PU}	Power-up time for all VDDs to reach minimum specified voltage (power ramps must be monotonic)	0.05	50	ms

Electrical Characteristics

For commercial and industrial temperature devices

Parameter	Description	Test Conditions	Min	Max	Unit
V _{IL}	Input LOW voltage [1]		-	0.8	V
V _{IH}	Input HIGH voltage [1]		2.0	_	V
I _{IL}	Input LOW current	V _{IN} = 0 V	-	50.0	μА
I _{IH}	Input HIGH current	$V_{IN} = V_{DD}$	-	100.0	μА
V_{OL}	Output LOW voltage [2]	I _{OL} = 8 mA	-	0.4	V
V _{OH}	Output HIGH voltage [2]	$I_{OH} = -8 \text{ mA}$	2.4	_	V
I _{DD}	Supply current	Unloaded outputs at 66.66 MHz	_	32	mA

Thermal Resistance

Parameter [3]	Description	Test Conditions	16-pin SOIC	Unit
- 3/1	,	Test conditions follow standard test methods and procedures for measuring thermal impedance, in		°C/W
00	Thermal resistance (junction to case)	accordance with EIA/JESD51.	60	°C/W

- 1. BUF_IN input has a threshold voltage of V_{DD}/2.
 2. Parameter is guaranteed by design and characterization. It is not 100% tested in production.
 3. These parameters are guaranteed by design and are not tested.

Document Number: 38-07182 Rev. *M



Switching Characteristics

For commercial and industrial temperature devices ^[4]

Parameter	Description	Condition	Min	Тур	Max	Unit
	Duty cycle ^[5] = $t_2 \div t_1$	Measured at 1.4 V	40.0	50.0	60.0	%
t ₃	Rise time ^[5]	Measured between 0.8 V and 2.0 V	_	_	1.50	ns
t ₄	Fall time ^[5]	Measured between 0.8 V and 2.0 V	_	_	1.50	ns
t ₅	Output to output skew ^[5]	All outputs equally loaded	_	-	250	ps
t ₆	Propagation delay, BUF_IN Rising edge to Output Rising edge ^[5]	Measured at V _{DD} /2	1	5	9.2	ns

Notes
4. All parameters specified with loaded outputs.
5. Parameter is guaranteed by design and characterization. It is not 100% tested in production.



Switching Waveforms

Figure 2. Duty Cycle Timing

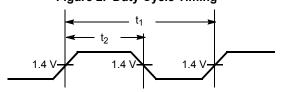


Figure 3. All Outputs Rise/Fall Time

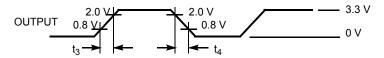


Figure 4. Output-Output Skew

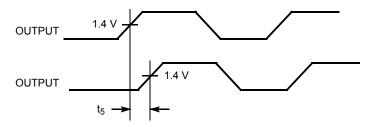
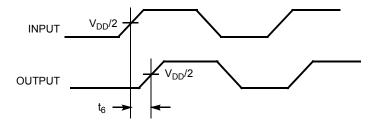
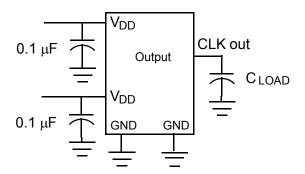


Figure 5. Input-Output Propagation Delay



Test Circuits

Figure 6. Test Circuits

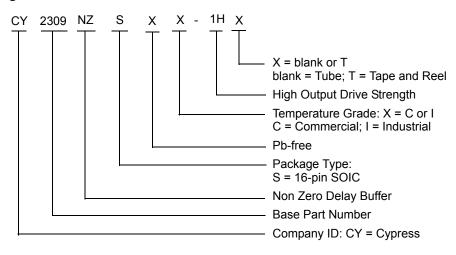




Ordering Information

Ordering Code	Package Type	Operating Range
Pb-free		
CY2309NZSXC-1H	16-pin SOIC (150 Mils)	Commercial
CY2309NZSXC-1HT	16-pin SOIC (150 Mils) – Tape and Reel	Commercial
CY2309NZSXI-1H	16-pin SOIC (150 Mils)	Industrial
CY2309NZSXI-1HT	16-pin SOIC (150 Mils) – Tape and Reel	Industrial

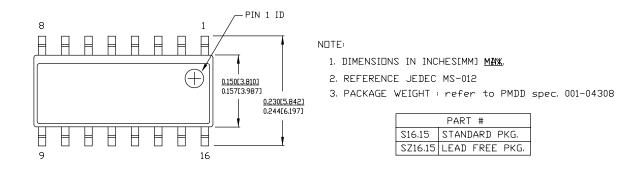
Ordering Code Definitions

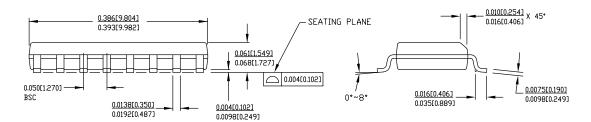




Package Diagram

Figure 7. 16-pin SOIC (150 Mils) S16.15/SZ16.15 Package Outline, 51-85068





51-85068 *E

Document Number: 38-07182 Rev. *M



Acronyms

Acronym	Description		
EMI	Electromagnetic Interference		
PLL	Phase-Locked Loop		
SOIC	Small-Outline Integrated Circuit		

Document Conventions

Units of Measure

Symbol	Unit of Measure		
°C	degrees Celsius		
MHz	megahertz		
μΑ	microampere		
mA	milliampere		
ms	millisecond		
mV	millivolt		
ns	nanosecond		
pF	picofarad		
V	volt		



Document History Page

Document Document	ocument Title: CY2309NZ, Nine-Output 3.3 V Buffer ocument Number: 38-07182				
Rev.	ECN	Orig. of Change	Submission Date	Description of Change	
**	111858	DSG	12/09/01	Change from Spec number: 38-00709 to 38-07182	
*A	121834	RBI	12/14/02	Power-up requirements added to Operating Conditions Information	
*B	130563	SDR	10/23/03	Added industrial operating temperature to operating conditions	
*C	212991	RGL / GGK	03/30/04	Updated the propagation delay T ₆ spec to 9.2 ns in the Switching Characteristics table	
*D	270149	RGL	10/04/04	Added Lead-free devices Replaced 8.7 ns Input/Output Delay to 1 ns Input/Output Delaying the features section	
*E	2568533	AESA	09/23/08	Changed "SDRAM [1:9]" to "OUTPUT [1:9]" in Operating Conditions table. Removed part number CY2309NZSI-1H and CY2309NZSI-1HT. Added Note "Not recommended for new designs." Updated to new template.	
*F	2904715	CXQ	04/05/10	Updated Ordering Information: Removed parts CY2309NZSC-1H, CY2309NZSC-1HT. Updated Package Diagram.	
*G	3082147	CXQ	11/10/2010	Updated Maximum Ratings: Changed the following from: "DC Input Voltage (Except REF)	
*H	4201460	CINM	11/25/2013	Updated Package Diagram: spec 51-85068 – Changed revision from *C to *E. Updated to new template. Completing Sunset Review.	
*	4578443	TAVA	11/25/2014	Updated Functional Description: Added "For a complete list of related documentation, click here." at the end.	
*J	4715451	XHT	04/10/2015	Updated Operating Conditions: Updated minimum value of BUF_IN, OUTPUT [1:9] parameter as 5 MHz.	
*K	4743611	TAVA	04/27/2015	Updated Operating Conditions: Changed minimum value of BUF_IN, OUTPUT [1:9] parameter from 5 MHz to 2 MHz. Updated to new template.	
*L	5260404	PSR	05/05/2016	Added Thermal Resistance. Updated to new template.	
*M	5553717	TAVA	12/14/2016	Updated to new template. Completing Sunset Review.	



Sales, Solutions, and Legal Information

Worldwide Sales and Design Support

Cypress maintains a worldwide network of offices, solution centers, manufacturer's representatives, and distributors. To find the office closest to you, visit us at Cypress Locations.

Products

ARM® Cortex® Microcontrollers cypress.com/arm Automotive cypress.com/automotive Clocks & Buffers cypress.com/clocks Interface cypress.com/interface Internet of Things cypress.com/iot Lighting & Power Control cypress.com/powerpsoc Memory cypress.com/memory **PSoC** cypress.com/psoc Touch Sensing cypress.com/touch **USB Controllers** cypress.com/usb Wireless/RF

cypress.com/wireless

PSoC®Solutions

PSoC 1 | PSoC 3 | PSoC 4 | PSoC 5LP

Cypress Developer Community

Forums | Projects | Video | Blogs | Training | Components

Technical Support

cypress.com/support

© Cypress Semiconductor Corporation, 2001-2016. This document is the property of Cypress Semiconductor Corporation and its subsidiaries, including Spansion LLC ("Cypress"). This document, including any software or firmware included or referenced in this document ("Software"), is owned by Cypress under the intellectual property laws and treaties of the United States and other countries worldwide. Cypress reserves all rights under such laws and treaties and does not, except as specifically stated in this paragraph, grant any license under its patents, copyrights, trademarks, or other intellectual property rights. If the Software is not accompanied by a license agreement and you do not otherwise have a written agreement with Cypress governing the use of the Software, then Cypress hereby grants you a personal, non-exclusive, nontransferable license (without the right to sublicense) (1) under its copyright rights in the Software (a) for Software provided in source code form, to modify and reproduce the Software solely for use with Cypress hardware products, only internally within your organization, and (b) to distribute the Software in binary code form externally to end users (either directly or indirectly through resellers and distributors), solely for use on Cypress hardware product units, and (2) under those claims of Cypress's patents that are infringed by the Software (as provided by Cypress, unmodified) to make, use, distribute, and import the Software solely for use with Cypress hardware products. Any other use, reproduction, modification, translation, or compilation of the Software is prohibited

TO THE EXTENT PERMITTED BY APPLICABLE LAW, CYPRESS MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARD TO THIS DOCUMENT OR ANY SOFTWARE OR ACCOMPANYING HARDWARE, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE. To the extent permitted by applicable law, Cypress reserves the right to make changes to this document without further notice. Cypress does not assume any liability arising out of the application or use of any product or circuit described in this document. Any information provided in this document, including any sample design information or programming code, is provided only for reference purposes. It is the responsibility of the user of this document to properly design, program, and test the functionality and safety of any application made of this information and any resulting product. Cypress products are not designed, intended, or authorized for use as critical components in systems designed or intended for the operation of weapons, weapons systems, nuclear installations, life-support devices or systems, other medical devices or systems (including resuscitation equipment and surgical implants), pollution control or hazardous substances management, or other uses where the failure of the device or system could cause personal injury, death, or property damage ("Unintended Uses"). A critical component is any component of a device or system whose failure to perform can be reasonably expected to cause the failure of the device or system, or to affect its safety or effectiveness. Cypress is not liable, in whole or in part, and you shall and hereby do release Cypress from any claim, damage, or other liability arising from or related to all Unintended Uses of Cypress products. You shall indemnify and hold Cypress harmless from and against all claims, costs, damages, and other liabilities, including claims for personal injury or death, arising from or related to any Unintended Uses of Cypress products.

Cypress, the Cypress logo, Spansion, the Spansion logo, and combinations thereof, PSoC, CapSense, EZ-USB, F-RAM, and Traveo are trademarks or registered trademarks of Cypress in the United States and other countries. For a more complete list of Cypress trademarks, visit cypress.com. Other names and brands may be claimed as property of their respective owners.

Document Number: 38-07182 Rev. *M Revised December 14, 2016 Page 11 of 11

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Clock Buffer category:

Click to view products by Cypress manufacturer:

Other Similar products are found below:

MPC962309EJ-1H NB4N121KMNG IDT49FCT805ASO MK2308S-1HILF PL133-27GI-R NB3L02FCT2G NB3L03FCT2G
ZL40200LDG1 ZL40205LDG1 9FG1200DF-1LF 9FG1001BGLF PI49FCT20802QE PI6C10810HE NB7L1008MNG NB7L14MN1G
PI49FCT20807QE PI6C4931502-04LIEX ZL80002QAB1 PI6C4931504-04LIEX PI6C10806BLEX ZL40226LDG1 8T73S208B-01NLGI
SY75578LMG PI49FCT32805QEX PL133-27GC-R MC10LVEP11DG MC10EP11DTG MC100LVEP11DG MC100E111FNG
MC100EP11DTG NB7L14MMNG NB6L14MMNR2G NB6L611MNG NB7V58MMNHTBG NB3N111KMNR4G ADCLK944BCPZ-R7
ZL40217LDG1 NB7LQ572MNG HMC940LC4BTR 9DB801BGLF ADCLK946BCPZ-REEL7 ADCLK946BCPZ ADCLK905BCPZ-R2
ADCLK905BCPZ-R7 ADCLK907BCPZ-R2 ADCLK907BCPZ-WP ADCLK914BCPZ-R2 ADCLK914BCPZ-R7 ADCLK925BCPZ-R2
ADCLK925BCPZ-R7